

REVERSE VOLTAGE 20V TO 200V FORWARD CURRENT 3.0A

DESCRIPTION

The SM320AF~SM3200AF is available in SMAF package

ORDERING INFORMATION

Package Type	Part Number				
SMAF	SM320AF				
	SM340AF				
	SM360AF				
	SM380AF				
	SM3100AF				
	SM3120AF				
	SM3150AF				
	SM3200AF				
Note	3,000pcs/Reel				
AiT provides all RoHS Compliant Products					

PIN DESCRIPTION



- 1. CATHODE
- 2. ANODE

FEATURES

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- Available in SMAF package

MECHANICAL DATA

Case: SMAF

Terminals: Solderable per MIL-STD-750,

Method 2026

Approx. Weight:27mg 0.00086oz

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ABSOLUTE MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter Parameter		Symbol	SM 320AF	SM 340AF	SM 360AF	SM 380AF	SM 3100AF	SM 3120AF	SM 3150AF	SM 3200AF	Unit
Maximum Repetitive Peak		V_{RRM}	20	40	60	80	100	120	150	200	V
Reverse Voltage			20	40	00	00	100	120	130	200	
Maximum RMS Volta	ige	V _{RMS}	14	28	42	56	70	84	105	140	V
Maximum DC Blockir	ng Voltage	V _{DC}	20	40	60	80	100	120	150	200	V
Maximum Average Forward		I _{F(AV)}	3.0								Α
Rectified Current		, ,									
Peak Forward Surge	Peak Forward Surge Current									ļ	
8.3ms Single Half Sine-Wave		I _{FSM}	80				70				Α
Superimposed on Rated Load		II OW									, ,
(JEDEC Method)											
Max Instantaneous Forward		V _F	0.55		0.70		0.85		0.95		V
Voltage at 3A		٧٢									
Maximum DC											
Reverse Current at	T _A =25°C	I _R	0	.5				0.3			mA
Rated DC Reverse	Reverse T _A =100°C		10		5.0						IIIA
Voltage											
Typical Junction		C _J	21	50	160						pF
Capacitance NOTE1		CJ	23	30							рг
Typical Thermal		В		40							
Resistance ^{NOTE2}		R _{θJA}	40								°C/W
Operating Junction		TJ	-55 ~125								°C
Temperature Range		13			-55 ~ 125						
Storage Temperature Range		Tstg	-55 ~150							°C	

NOTE1: Measured at 1MHz and applied reverse voltage of 4V D.C.

NOTE2: P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

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TYPICAL CHARACTERISTICS

Figure. 1 Forward Current Derating Curve

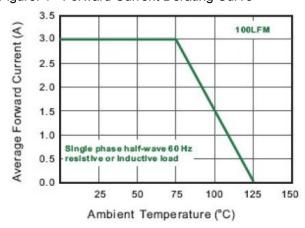
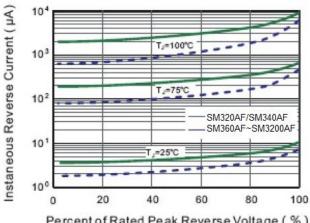


Figure. 2 Typical Reverse Characteristics



Percent of Rated Peak Reverse Voltage (%)

Figure. 3 Typical Forward Characteristic

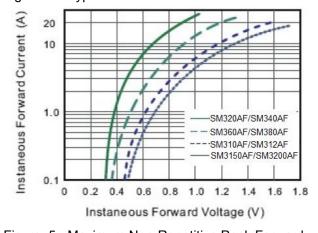


Figure. 4 **Typical Junction Capacitance**

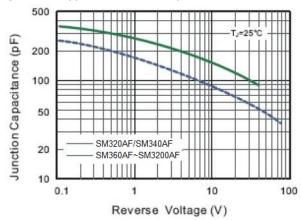


Figure. 5 Maximum Non-Repetitive Peak Forward Surge Current

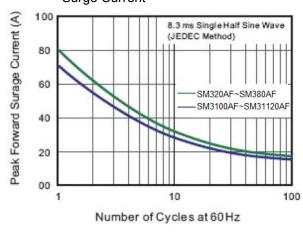
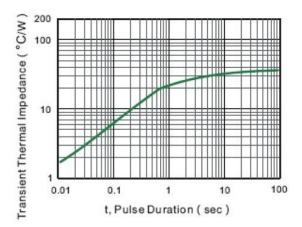


Figure. 6 Typical Transient Thermal Impedance

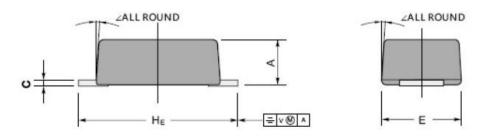


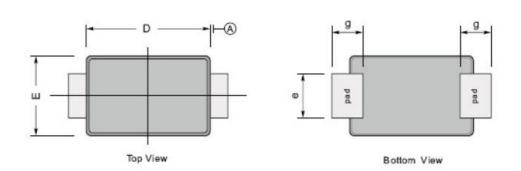
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PACKAGE INFORMATION

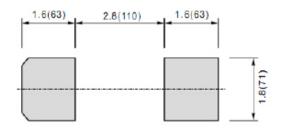
Dimension in SMAF (Unit: mm)

Plastic surface mounted package; 2 leads





The recommended mounting pad size



Unit: mm(mil)

UN	VIT	Α	В	C	Е	е	g	HE	4
mm	Max	1.3	0.23	3.7	2.7	1.6	1.3	4.9	7 °
	Min	1.1	0.18	3.3	2.4	1.3	1.0	4.4	
mil	Max	51	9.1	146	106	63	51	193	/
	Min	43	7.1	130	94	51	39	173	

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